

MOSFET Maximum Ratings T_J = 25°C unless otherwise noted.

Symbol	Parameter		Ratings	Units
V _{DSS}	Drain-to-Source Voltage		40	V
V _{GS}	Gate-to-Source Voltage		±20	V
	Drain Current - Continuous (V _{GS} =10) (Note 1)	T _C =25°C	90	•
I _D	Pulsed Drain Current	T _C = 25°C	See Figure 4	— A
E _{AS}	Single Pulse Avalanche Energy	(Note 2)	33.7	mJ
P _D	Power Dissipation		94	W
	Derate Above 25°C		0.63	W/ ^o C
T _J , T _{STG}	Operating and Storage Temperature		-55 to + 175	°C
$R_{\theta JC}$	Thermal Resistance, Junction to Case		1.6	°C/W
R _{0JA}	Maximum Thermal Resistance, Junction to Ambient	(Note 3)	43	°C/W

Notes:

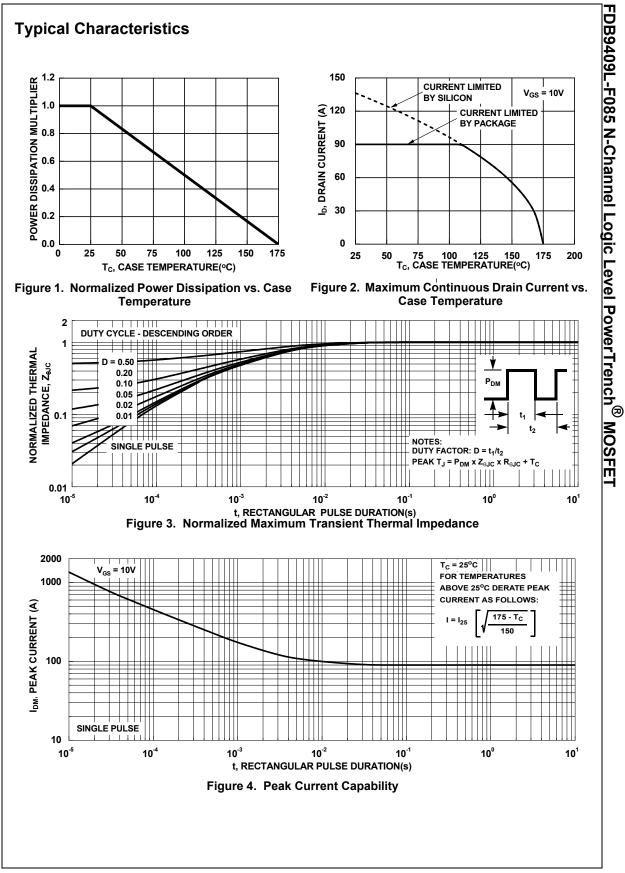
1: Current is limited by bondwire configuration.

2: Starting T_J = 25°C, L = 15µH, I_{AS} = 67A, V_{DD} = 40V during inductor charging and V_{DD} = 0V during time in avalanche. 3: R_{0JA} is the sum of the junction-to-case and case-to-ambient thermal resistance, where the case thermal reference is defined as the solder mounting surface of the drain pins. $R_{\theta JC}$ is guaranteed by design, while $R_{\theta JA}$ is determined by the board design. The maximum rating presented here is based on mounting on a 1 in² pad of 2oz copper.

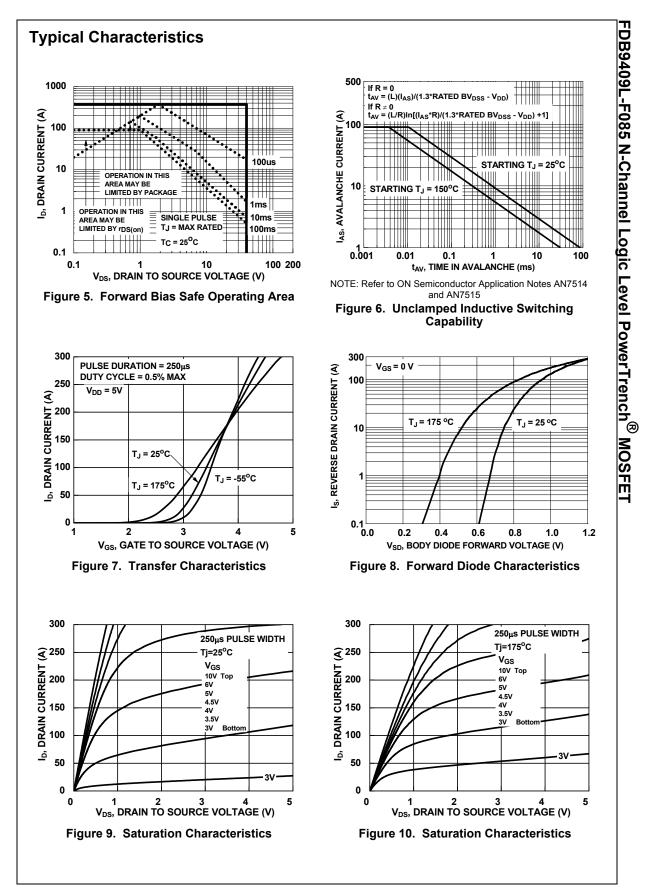
Package Marking and Ordering Information

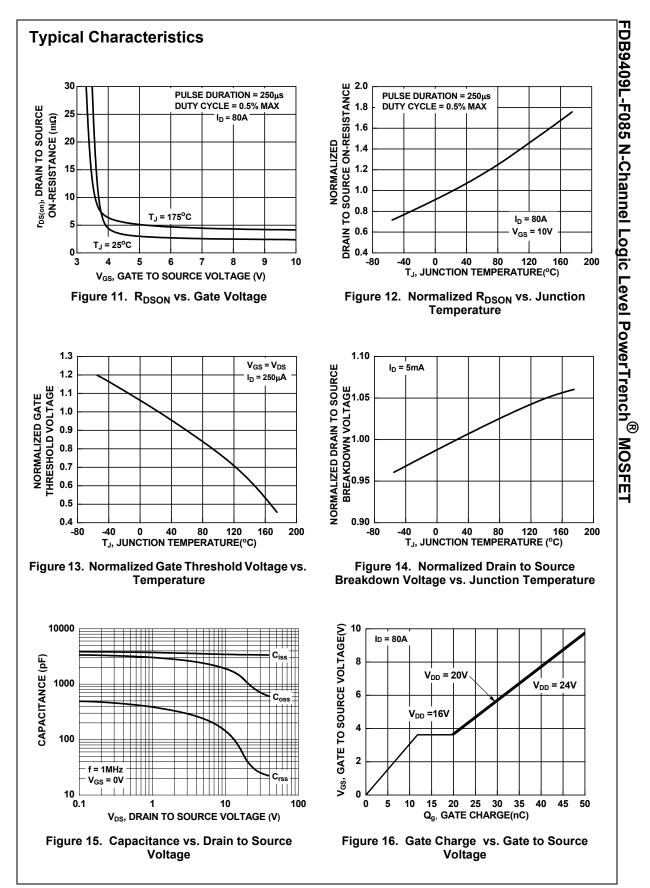
Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FDB9409L	FDB9409L-F085	TO-263AB	330mm	24mm	800units

Symbol	Parameter	Test Conditions		Min.	Тур.	Max.	Units
Off Cha	aracteristics						
B _{VDSS}	Drain-to-Source Breakdown Voltage	I _D = 250μA, V _{GS} = 0V		40	-	-	V
I _{DSS}	Drain-to-Source Leakage Current	V_{DS} =40V, T_{J} = 25°C		-	-	1	μA
		$V_{GS} = 0V$	T _J = 175 ^o C (Note 4)	-	-	1	mA
I _{GSS}	Gate-to-Source Leakage Current	$V_{GS} = \pm 20V$		-	-	±100	nA
On Cha	racteristics						
V _{GS(th)}	Gate to Source Threshold Voltage	V _{GS} = V _{DS} , I _D = 250μA		1.0	1.8	3.0	V
(**)		I _D = 80A, V _G		-	3.2	4.7	mΩ
R _{DS(on)}	Drain to Source On Resistance	I _D = 80A,	T _J = 25 ^o C	-	2.3	2.9	mΩ
		V _{GS} = 10V	$T_{J} = 175^{\circ}C$ (Note 4)	-	4.0	5.0	mΩ
Dynami	ic Characteristics						
C _{iss}	Input Capacitance			-	3360	-	pF
C _{oss}	Output Capacitance			-	1080	-	pF
C _{rss}	Reverse Transfer Capacitance			-	42	-	pF
۲ _g	Gate Resistance	f = 1MHz		-	2.2	-	Ω
ຊ _{g(ToT)}	Total Gate Charge	V _{GS} = 0 to 1	0V V _{DD} = 32V	-	52	68	nC
ସୁ _{g(th)}	Threshold Gate Charge	V _{GS} = 0 to 2	V I _D = 80A	-	6	-	nC
Q _{gs}	Gate-to-Source Gate Charge			-	12	-	nC
Q _{gd}	Gate-to-Drain "Miller" Charge			-	8	-	nC
Switchi	ng Characteristics						
on	Turn-On Time			-	-	53	ns
d(on)	Turn-On Delay	V_{DD} = 20V, I_D = 80A, V_{GS} = 10V, R_{GEN} = 6 Ω		-	11	-	ns
r	Rise Time			-	25	-	ns
d(off)	Turn-Off Delay			-	38	-	ns
f	Fall Time			-	10	-	ns
	Turn-Off Time			-	-	72	ns



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